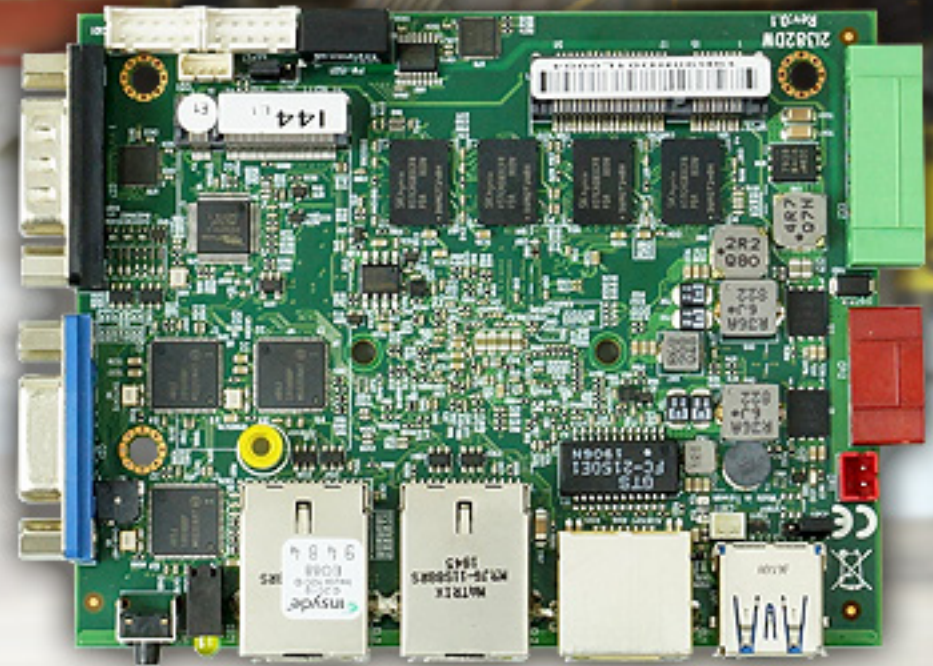


**3 x Intel GbE with
2 x COM (DB9/Phoenix isolated)
compact SBC power by
Intel Atom™ Bay-Trail processor**



21382DW Series



21382DW

3 x Intel GbE with 2 x COM (DB9 / Phoenix isolated) compact SBC power by Intel Atom™ Bay-Trail processor

LEX SYSTEM 21382DW SBC with built-in 3 x Intel Giga LAN, 4 x USB , 2 COM as a flexible hardware platform for industrial communication solution. A reliable and efficient communication network which connects all the components of the factory to work together effectively plays an important role of success industrial automation. 21382DW provides customers a robust, wide range power input and compact computing system with an industrial design and built-in I/O to handle diverse applications.

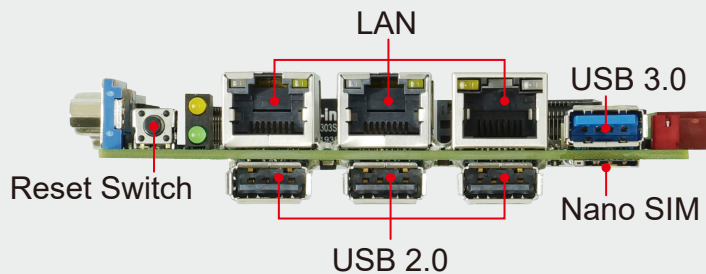
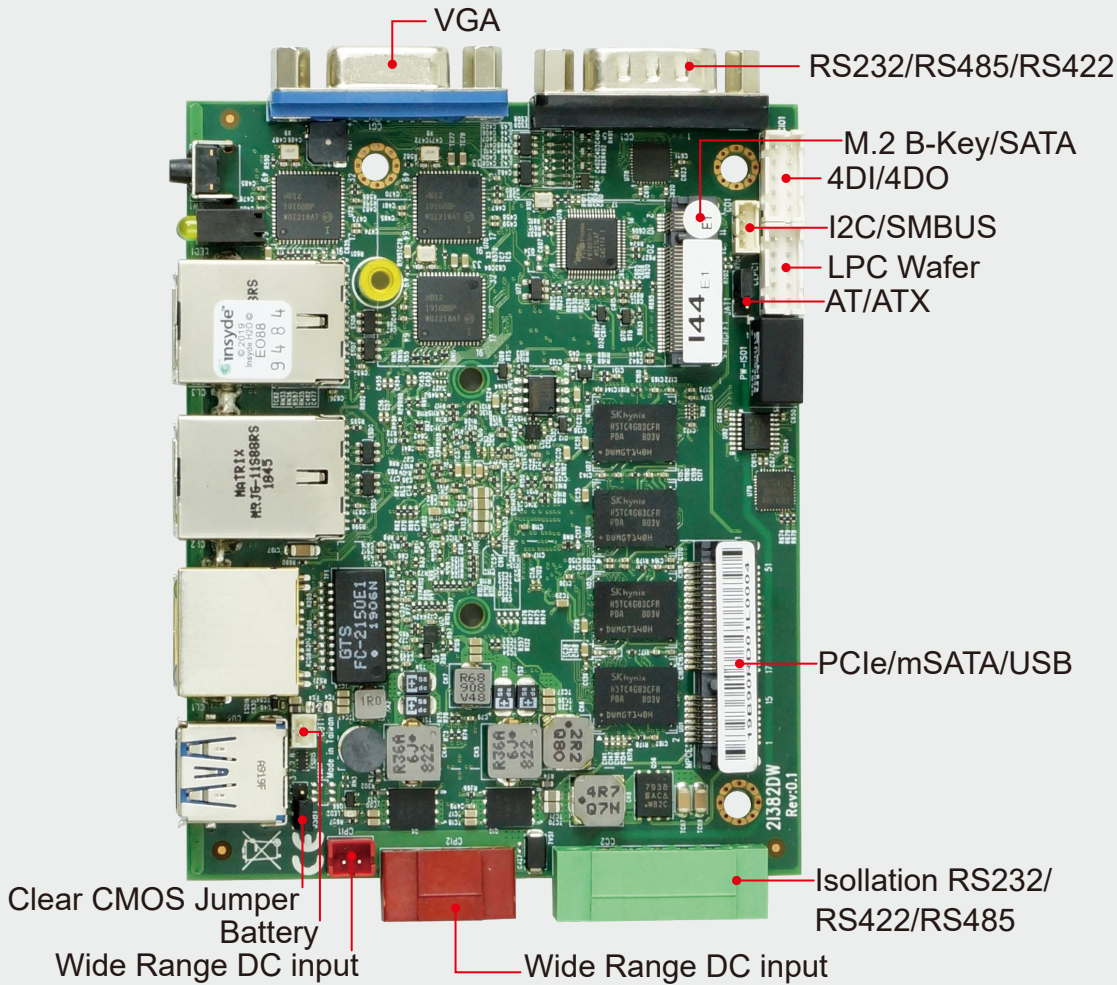
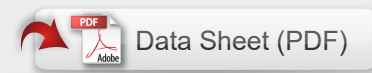
Function MAP



21382DW

21382DW –ideal industrial networking solution

- Intel® Bay Trail E3825 / E3845/J1900 CPU / chipset
- On Board DDR3L 2GB / 4GB
- Independent display: VGA
- 3 x Intel GbE I210IT ,1 x USB 3.0, 3 x USB 2.0
- 2 x COM, RS232/422/485 (DB9+Phoenix isolation)
- 1 x Full size Mini PCIe (PCIe / mSATA / USB)
- 1 x M.2 B Key, Type 2242 (SATA)
- 1 x Nano SIM (option)
- 4 DI / 4DO
- Wide Range +12~36V
- Wide temperature support of -20°C ~ 70°C





NET-II + 2I382DW

NET-II

Dimension: 30H x 110W x 90D mm

- Ultra compact & Fanless DIN Rail system
- Industrial Networking System